IGBT - Field Stop

600 V, 40 A

FGH40N60SMD

Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 \text{ V} (Typ) @ I_C = 40 \text{ A}$
- High Input Impedance
- Fast Switching: $E_{OFF} = 6.5 \mu J/A$
- Tighten Parameter Distribution
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

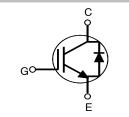
Applications

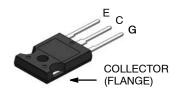
• Solar Inverter, Welder, UPS, PFC, Telecom, ESS



ON Semiconductor®

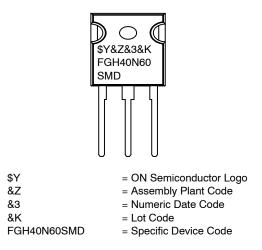
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TO-247-3LD CASE 340CK

MARKING DIAGRAMS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ratings	Unit	
Collector to Emitter Voltage	V _{CES}	600	V	
Gate to Emitter Voltage		V _{GES}	±20	V
Transient Gate to Emitter Voltage		±30	V	
Collector Current	Collector Current $T_{C} = 25^{\circ}C$		80	А
Collector Current	T _C = 100°C	7	40	А
Pulsed Collector Current (Note 1)	sed Collector Current (Note 1) $T_{\rm C} = 25^{\circ}{\rm C}$		120	А
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	١ _F	40	А
Diode Forward Current T _C = 100°C		7	20	А
Pulsed Diode Maximum Forward Current (Note 1)	I _{FM}	120	А	
Maximum Power Dissipation	Maximum Power Dissipation $T_{C} = 25^{\circ}C$		349	W
Maximum Power Dissipation $T_{C} = 100^{\circ}C$		7	174	W
Operating Junction Temperature	TJ	–55 to +175	°C	
Storage Temperature Range	T _{stg}	–55 to +175	°C	
Maximum Lead Temp. for Soldering Purposes, 1/8" from	TL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Characteristic		Value	Unit
Thermal Resistance, Junction to Case (IGBT)	$R_{\theta JC}$	0.43	°C/W
Thermal Resistance, Junction to Case (Diode)	$R_{\theta JC}$	1.5	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH40N60SMD	FGH40N60SMD	TO-247-3LD	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS				-		
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 250 μ A	600	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES} / \Delta T_{J}$	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \ \mu\text{A}$	-	0.6	-	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICS						
G-E Threshold Voltage	V _{GE(th)}	I_C = 250 μ A, V_{CE} = V_{GE}	3.5	4.5	6.0	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 40 A, V _{GE} = 15 V	-	1.9	2.5	V
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 175°C	-	2.1	-	V

ELECTRICAL CHARACTERISTICS OF THE IGBT	$(T_{C} = 25^{\circ}C \text{ unless otherwise noted})$ (continued)
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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ies}	$V_{CE} = 30 \text{ V}, \text{ V}_{GE} = 0 \text{ V},$	-	1880	-	pF
Output Capacitance	C _{oes}	f = 1 MHz	-	180	-	pF
Reverse Transfer Capacitance	C _{res}		-	50	_	pF
SWITCHING CHARACTERISTICS				-	-	-
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, I_C = 40 \text{ A},$	-	12	16	ns
Rise Time	t _r	$R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	20	28	ns
Turn-Off Delay Time	t _{d(off)}		-	92	120	ns
Fall Time	t _f		-	13	17	ns
Turn-On Switching Loss	E _{on}		-	0.87	1.30	mJ
Turn-Off Switching Loss	E _{off}		-	0.26	0.34	mJ
Total Switching Loss	E _{ts}		-	1.13	1.64	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V, } I_C = 40 \text{ A,}$ $R_G = 6 \Omega, V_{GE} = 15 \text{ V,}$ Inductive Load, T _C = 175°C	-	15	-	ns
Rise Time	t _r		_	22	-	ns
Turn-Off Delay Time	t _{d(off)}		-	116	_	ns
Fall Time	t _f		-	16	_	ns
Turn-On Switching Loss	E _{on}		-	0.97	_	mJ
Turn-Off Switching Loss	E _{off}		-	0.60	-	mJ
Total Switching Loss	E _{ts}		-	1.57	-	mJ
Total Gate Charge	Qg	V_{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	-	119	180	nC
Gate to Emitter Charge	Q _{ge}		-	13	20	nC
Gate to Collector Charge	Q _{gc}		-	58	90	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 20 A	$T_C = 25^{\circ}C$	-	2.3	2.8	V
			T _C = 175°C	-	1.67	-	V
Reverse Recovery Energy	E _{rec}	I _F = 20 A, dI _F /dt = 200 A/μs,	T _C = 175°C	-	48.9	-	μJ
Diode Reverse Recovery Time	t _{rr}		$T_C = 25^{\circ}C$	-	36	-	ns
			T _C = 175°C	-	110		ns
Diode Reverse Recovery Charge	Q _{rr}		$T_{C} = 25^{\circ}C$	-	46.8	-	nC
			T _C = 175°C	-	445		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

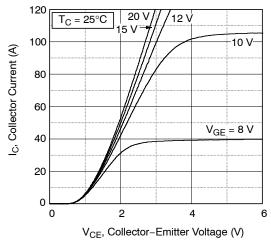


Figure 1. Typical Output Characteristics

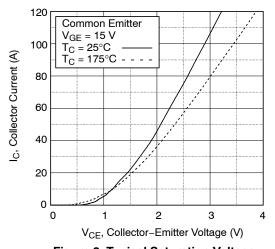
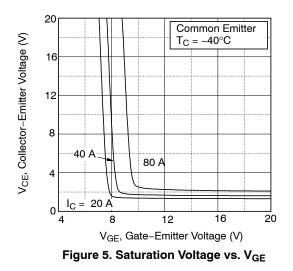


Figure 3. Typical Saturation Voltage Characteristics



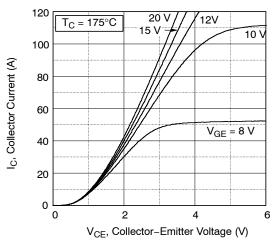


Figure 2. Typical Output Characteristics

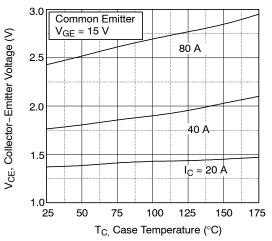
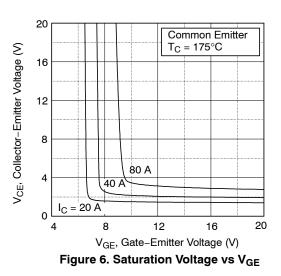


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

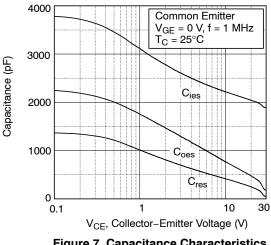
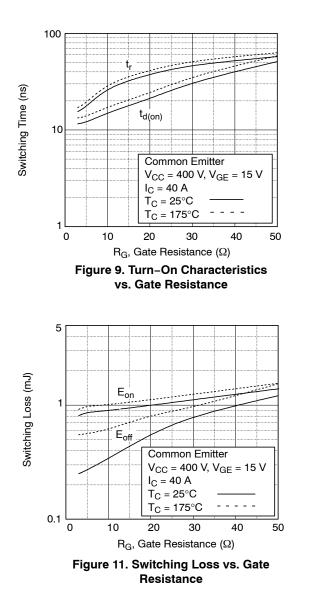


Figure 7. Capacitance Characteristics



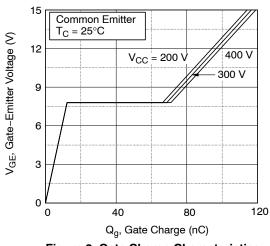


Figure 8. Gate Charge Characteristics

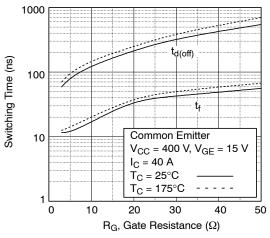
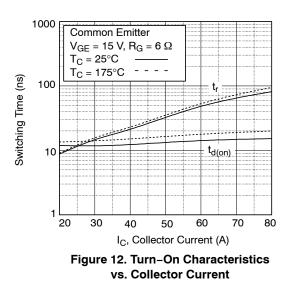
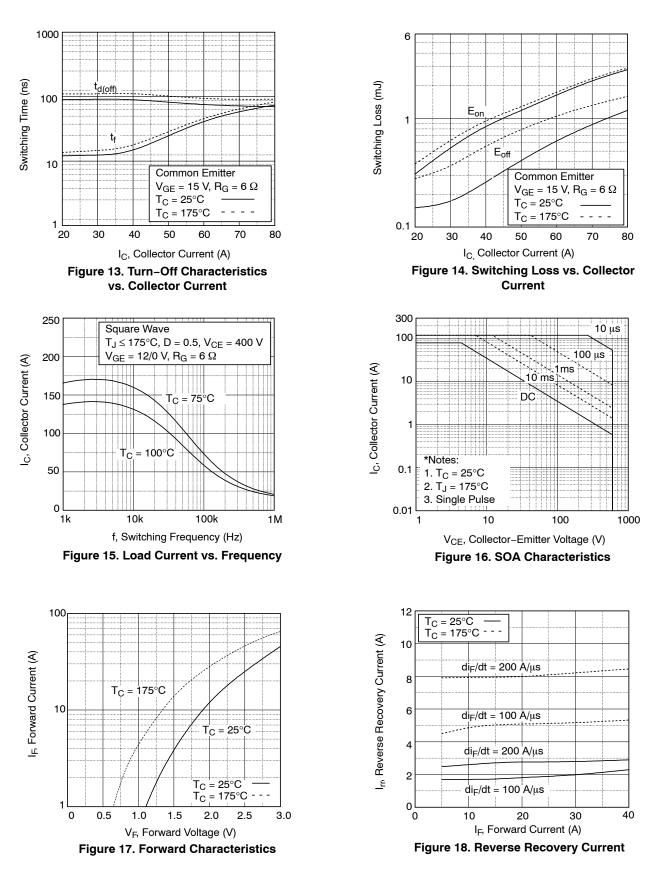


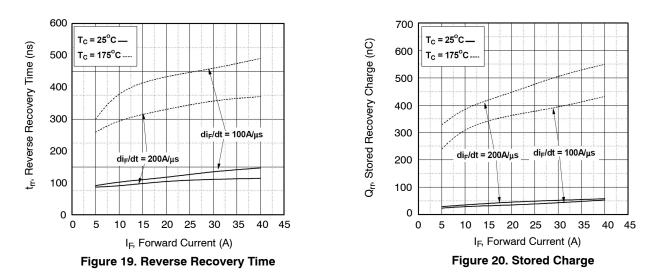
Figure 10. Turn-Off Characteristics vs. Gate Resistance

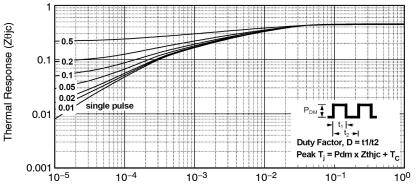


TYPICAL PERFORMANCE CHARACTERISTICS (continued)



TYPICAL PERFORMANCE CHARACTERISTICS (continued)





Rectangular Pulse Duration (sec)

Figure 21. Transient Thermal Impedance of IGBT

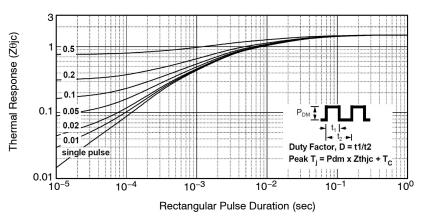


Figure 22. Time Transient Thermal Impedance of Diode





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